# 5917738-4 ✓ ACTIVE

#### **CHAMP**

TE Internal #: 5917738-4

PCB D-Sub Connectors, Receptacle, Board-to-Board, 26 Position, 1.27 mm [.05 in] Centerline, 4 Row, Standard Profile, Right Angle,

PCB Mount Retention

View on TE.com >



Connectors > D-Shaped Connectors > D-Sub Connectors > PCB D-Sub Connectors











Connector & Housing Type: Receptacle

Connector System: Board-to-Board

Number of Positions: 26

Centerline (Pitch): 1.27 mm [ .05 in ]

Number of Rows: 4

### **Features**

# **Product Type Features**

Shell Material Configuration	Front Metal Shell
Connector & Housing Type	Receptacle
Connector System	Board-to-Board
Connector & Contact Terminates To	Printed Circuit Board
Configuration Features	
Number of Positions	26
Number of Rows	4
PCB Mount Orientation	Right Angle
Body Features	
Shell Plating Material	Nickel over Copper
Primary Product Color	Black
Connector Profile	Standard

Gold

**Contact Features** 

Contact Mating Area Plating Material



Shell Material  Housing Material  PBT  Centerline (Pitch)  1.27 mm[.05 in]  Dimensions  PCB Thickness (Recommended)  Row-to-Row Spacing  1.9 mm[.075 in]  Operation/Application  Circuit Application  Signal		
Termination Features  Rectangular Termination Post & Tail Thickness	PCB Contact Termination Area Plating Material	Tin
Rectangular Termination Post & Tail Thickness  Rectangular Termination Post & Tail Width  .5 mm[.019 in]  Termination Post & Tail Length  3.1 mm[.122 in]  Termination Method to Printed Circuit Board  Mechanical Attachment  Mounting Hole Diameter  PCB Mount Retention  With  PCB Mount Retention Type  Boardlock  Mating Retention Type  Latches  Connector Mounting Type  Panel Mount  Housing Features  Shell Material  Housing Material  PBT  Centerline (Pitch)  Dimensions  PCB Thickness (Recommended)  Row-to-Row Spacing  Operation/Application  Circuit Application  Signal	Contact Base Material	Copper Alloy
Rectangular Termination Post & Tail Width .5 mm .019 in  Termination Post & Tail Length 3.1 mm[.122 in] Termination Method to Printed Circuit Board Through Hole - Solder  Mechanical Attachment  Mounting Hole Diameter 2.7 mm  PCB Mount Retention With  PCB Mount Retention Type Boardlock  Mating Retention With  Mating Retention Type Latches  Connector Mounting Type Panel Mount  Housing Features  Shell Material Steel  Housing Material PBT  Centerline (Pitch) 1.27 mm[.05 in]  Dimensions  PCB Thickness (Recommended) 1.66 mm  Row-to-Row Spacing 1.9 mm[.075 in]  Operation/Application  Circuit Application	Termination Features	
Termination Post & Tail Length Termination Method to Printed Circuit Board  Mechanical Attachment  Mounting Hole Diameter PCB Mount Retention With PCB Mount Retention Type Boardlock Mating Retention Type Latches Connector Mounting Type Panel Mount Housing Features  Shell Material Housing Material PBT Centerline (Pitch) Dimensions  PCB Thickness (Recommended) Row-to-Row Spacing Operation/Application  Signal	Rectangular Termination Post & Tail Thickness	.32 mm[.012 in]
Termination Method to Printed Circuit Board  Mechanical Attachment  Mounting Hole Diameter 2.7 mm  PCB Mount Retention With  PCB Mount Retention Type Boardlock  Mating Retention Type Latches  Connector Mounting Type Panel Mount  Housing Features  Shell Material Steel  Housing Material PBT  Centerline (Pitch) 1.27 mm[.05 in]  Dimensions  PCB Thickness (Recommended) 1.66 mm  Row-to-Row Spacing 1.9 mm[.075 in]  Operation/Application  Circuit Application  Signal	Rectangular Termination Post & Tail Width	.5 mm[.019 in]
Mechanical Attachment  Mounting Hole Diameter 2.7 mm  PCB Mount Retention With  PCB Mount Retention Type Boardlock  Mating Retention With  Mating Retention Type Latches  Connector Mounting Type Panel Mount  Housing Features  Shell Material Steel  Housing Material PBT  Centerline (Pitch) 1.27 mm[.05 in]  Dimensions  PCB Thickness (Recommended) 1.66 mm  Row-to-Row Spacing 1.9 mm[.075 in]  Operation/Application  Circuit Application Signal	Termination Post & Tail Length	3.1 mm[.122 in]
Mounting Hole Diameter  PCB Mount Retention  With  PCB Mount Retention Type  Boardlock  Mating Retention  With  Mating Retention Type  Latches  Connector Mounting Type  Panel Mount  Housing Features  Shell Material  Housing Material  PBT  Centerline (Pitch)  Dimensions  PCB Thickness (Recommended)  Row-to-Row Spacing  Operation/Application  Circuit Application	Termination Method to Printed Circuit Board	Through Hole - Solder
PCB Mount Retention Type Boardlock Mating Retention Mith Mating Retention Type Latches Connector Mounting Type Panel Mount Housing Features  Shell Material Housing Material PBT Centerline (Pitch) 1.27 mm[.05 in]  Dimensions  PCB Thickness (Recommended) Row-to-Row Spacing Operation/Application  Circuit Application  Signal	Mechanical Attachment	
PCB Mount Retention Type  Mating Retention  Mating Retention Type  Latches  Connector Mounting Type  Panel Mount  Housing Features  Shell Material  Housing Material  Centerline (Pitch)  Dimensions  PCB Thickness (Recommended)  Row-to-Row Spacing  Circuit Application  Signal	Mounting Hole Diameter	2.7 mm
Mating Retention Type Latches  Connector Mounting Type Panel Mount  Housing Features  Shell Material Steel  Housing Material PBT  Centerline (Pitch) 1.27 mm[.05 in]  Dimensions  PCB Thickness (Recommended) 1.66 mm  Row-to-Row Spacing 1.9 mm[.075 in]  Operation/Application  Circuit Application Signal	PCB Mount Retention	With
Mating Retention Type  Connector Mounting Type  Panel Mount  Housing Features  Shell Material  Steel  Housing Material  PBT  Centerline (Pitch)  1.27 mm[.05 in]  Dimensions  PCB Thickness (Recommended)  Row-to-Row Spacing  1.9 mm[.075 in]  Operation/Application  Circuit Application  Signal	PCB Mount Retention Type	Boardlock
Connector Mounting Type Panel Mount  Housing Features  Shell Material Steel  Housing Material PBT  Centerline (Pitch) 1.27 mm[.05 in]  Dimensions  PCB Thickness (Recommended) 1.66 mm  Row-to-Row Spacing 1.9 mm[.075 in]  Operation/Application  Circuit Application Signal	Mating Retention	With
Housing Features  Shell Material Steel  Housing Material PBT  Centerline (Pitch) 1.27 mm[.05 in]  Dimensions  PCB Thickness (Recommended) 1.66 mm  Row-to-Row Spacing 1.9 mm[.075 in]  Operation/Application  Circuit Application Signal	Mating Retention Type	Latches
Shell Material  Housing Material  PBT  Centerline (Pitch)  1.27 mm[.05 in]  Dimensions  PCB Thickness (Recommended)  Row-to-Row Spacing  1.9 mm[.075 in]  Operation/Application  Circuit Application  Signal	Connector Mounting Type	Panel Mount
Housing Material PBT  Centerline (Pitch) 1.27 mm[.05 in]  Dimensions  PCB Thickness (Recommended) 1.66 mm  Row-to-Row Spacing 1.9 mm[.075 in]  Operation/Application  Circuit Application Signal	Housing Features	
Centerline (Pitch)  Dimensions  PCB Thickness (Recommended)  Row-to-Row Spacing  1.9 mm[.075 in]  Operation/Application  Circuit Application  Signal	Shell Material	Steel
Dimensions  PCB Thickness (Recommended)  Row-to-Row Spacing  1.9 mm[.075 in]  Operation/Application  Circuit Application  Signal	Housing Material	PBT
PCB Thickness (Recommended)  Row-to-Row Spacing  1.9 mm[.075 in]  Operation/Application  Circuit Application  Signal	Centerline (Pitch)	1.27 mm[.05 in]
Row-to-Row Spacing 1.9 mm[.075 in]  Operation/Application Signal	Dimensions	
Operation/Application  Circuit Application  Signal	PCB Thickness (Recommended)	1.66 mm
Circuit Application Signal	Row-to-Row Spacing	1.9 mm[.075 in]
	Operation/Application	
Poolsoging Footuses	Circuit Application	Signal
rackaging reatures	Packaging Features	
Packaging Quantity 120	Packaging Quantity	120
Packaging Method Tray	Packaging Method	Tray

# **Product Compliance**

For compliance documentation, visit the product page on TE.com>

EU RoHS Directive 2011/65/EU	Compliant
EU ELV Directive 2000/53/EC	Compliant
China RoHS 2 Directive MIIT Order No 32, 2016	No Restricted Materials Above Threshold



EU REACH Regulation (EC) No. 1907/2006 Current ECHA Candidate List: JUNE 2023

(235)

Candidate List Declared Against: JUNE

2023 (235)

Does not contain REACH SVHC

Halogen Content Not Low Halogen - contains Br or Cl > 900

ppm.

Solder Process Capability Wave solder capable to 265°C

#### Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach

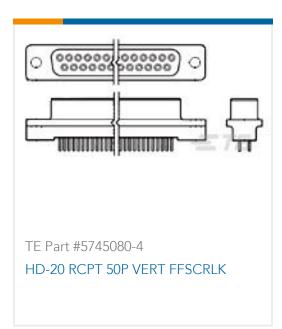
# **Customers Also Bought**





















### **Documents**

# **Product Drawings**

CHAMP 050 FMS REC HDR ASSY 26P

English

#### **CAD Files**

**Customer View Model** 

ENG\_CVM\_CVM\_5917738-4\_O.2d\_dxf.zip

English

3D PDF

3D

**Customer View Model** 

ENG\_CVM\_CVM\_5917738-4\_O.3d\_igs.zip

English

**Customer View Model** 

ENG\_CVM\_CVM\_5917738-4\_O.3d\_stp.zip

English

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Product Environmental Compliance

MD\_5917738-4\_04242012942

English

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